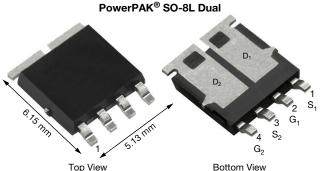


Vishay Siliconix

Automotive N- and P-Channel 40 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY	1	
	N-CHANNEL	P-CHANNEL
V _{DS} (V)	40	-40
$R_{DS(on)} (\Omega)$ at $V_{GS} = \pm 10 \text{ V}$	0.0092	0.0270
$R_{DS(on)} (\Omega)$ at $V_{GS} = \pm 4.5 \text{ V}$	0.0112	0.0435
I _D (A)	30	-30
Configuration	N- and	P-Pair

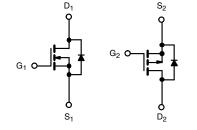


FEATURES

- TrenchFET[®] Power MOSFET
- AEC-Q101 Qualified^d
- 100 % R_a and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE



N-Channel MOSFET P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SQJ500AEP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless	otherwise n	ioted)			
PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT	
Drain-Source Voltage		V _{DS}	40	-40	v	
Gate-Source Voltage		V _{GS}	±	v		
Continuous Drain Current ^a	T _C = 25 °C	I	30	-30		
Continuous Drain Current~	T _C = 125 °C	ID	30 -18			
Continuous Source Current (Diode Conduction) ^a		I _S	30	-30	А	
Pulsed Drain Current ^b		I _{DM}	120	-120		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	26.5	-25		
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	35	31	mJ	
Maximum Dawar Dissinction ^b	T _C = 25 °C	Р	48	48	14/	
Maximum Power Dissipation ^b	T _C = 125 °C	PD	16	16	W	
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	-55 to +175		°C	
Soldering Recommendations (Peak Temperature	e) ^{e, f}		20	60		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	85	85	°C/W
Junction-to-Case (Drain)		R _{thJC}	3.1	3.1	C/W

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).

d. Parametric verification ongoing.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components. f.

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Document Number: 62878

For technical questions, contact: automostechsupport@vishay.com

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e. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

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Vishay Siliconix

SPECIFICATIONS ($T_C = 25$	1	otherwise no	ted)		1	1	1		
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$ N		N-Ch	40	-	-		
Brain Gource Breakdown Voltage	VD5	V _{GS} =	0 V, I _D = - 250 μA	P-Ch	-40	-	-	v	
Gate-Source Threshold Voltage	Veen	V _{DS} =	: V _{GS} , I _D = 250 μΑ	N-Ch	1.3	1.8	2.3	v	
date-Source mieshold voltage	V _{GS(th)}	$V_{DS} =$	V _{GS} , I _D = - 250 μA	P-Ch	-1.5	-2	-2.5		
Cata Source Leakage	1	V	0 V, V _{GS} = ± 20 V	N-Ch	-	-	± 100	r ^	
Gate-Source Leakage	I _{GSS}	v _{DS} =	v , $v_{GS} = \pm 20$ v	P-Ch	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 40 V	N-Ch	-	-	1		
		$V_{GS} = 0 V$	V _{DS} = -40 V	P-Ch	-	-	-1		
Zaus Cata Malta as Dusis Compart		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	N-Ch	-	-	50		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 125 °C	P-Ch	-	-	-50	μA	
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	N-Ch	-	-	150		
		$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 175 °C	P-Ch	-	-	-150		
		V _{GS} = 10 V	$V_{DS} \ge 5 V$	N-Ch	25	-	-	_	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le 5 V$	P-Ch	-25	-	-	A	
		V _{GS} = 10 V	I _D = 9.8 A	N-Ch	-	0.0077	0.0092		
		V _{GS} = -10 V	I _D = -6 A	P-Ch	-	0.0220	0.0270		
	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.8 A, T _J = 125 °C	N-Ch	-	-	0.0138	Ω	
		V _{GS} = -10 V	I _D = -6 A, T _J = 125 °C	P-Ch	-	-	0.0380		
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 9.8 A, T _J = 175 °C	N-Ch	-	-	0.0170		
		V _{GS} = -10 V	I _D = -6 A, T _J = 175 °C	P-Ch	-	-	0.0460		
		$V_{GS} = 4.5 V$	I _D = 8.9 A	N-Ch	-	0.0094	0.0112		
		V _{GS} = -4.5 V	I _D = -4.7 A	P-Ch	-	0.0360	0.0435		
			= 15 V, I _D = 9.8 A	N-Ch	_	65	-		
Forward Transconductance ^b	9 _{fs}		= -15 V, I _D = -6 A	P-Ch	-	16	_	S	
Dynamic ^b		.03					l		
2 jiidiilio		V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch	- 1	1474	1843	[
Input Capacitance	Ciss	$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = -20 \text{ V}, \text{ f} = 1 \text{ MHz}$	P-Ch	_	1302	1628		
		$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = 20 V, f = 1 MHz$	N-Ch	_	218	273		
Output Capacitance	Coss	$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = -20 \text{ V}, \text{ f} = 1 \text{ MHz}$	P-Ch	_	222	278	pF	
		$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = 20 V$, f = 1 MHz	N-Ch		89	111		
Reverse Transfer Capacitance	C _{rss}	$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = -20 V$, f = 1 MHz	P-Ch	_	154	193		
		V _{GS} = 0 V V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, \text{ I} = 10 \text{ A}$ $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	N-Ch	-	25.5	38.3		
Total Gate Charge ^c	Qg	$V_{GS} = 10 V$ $V_{GS} = -10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $V_{DS} = -20 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	P-Ch		30.2	45	1	
	-	$v_{GS} = -10 V$ $V_{GS} = 10 V$	$V_{DS} = -20 \text{ V}, \text{ I}_{D} = -10 \text{ A}$ $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	N-Ch	-	4.4	45		
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 10 V$ $V_{GS} = -10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $V_{DS} = -20 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	P-Ch		4.4	-	nC	
	3 *				-			-	
Gate-Drain Charge ^c	Q _{gd}	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	N-Ch P-Ch	-	4.3	-	-	
	Ŭ	$v_{GS} = -10 V$	$V_{GS} = -10 \text{ V}$ $V_{DS} = -20 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		-	7.4	-		
Gate Resistance	Rg		f = 1 MHz	N-Ch	0.65	1.37	2.1	Ω	
	5			P-Ch	3.1	6.15	9.5		

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SPECIFICATIONS ($T_C = 25$	ο °C, unless c	otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
	+	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	8	12	
Turn-On Delay Time ^c	t _{d(on)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = -20 \mbox{ V, } R_L = 2 \ \Omega \\ I_D \cong -10 \mbox{ A, } V_{GEN} = -10 \mbox{ V, } R_g = 1 \ \Omega \end{array}$	P-Ch	-	7	11	
Rise Time ^c	tr	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	12	18	2 1 8 3 3 4 6 8 20 2 V
	۲r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{-20 V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong \text{-10 A}, \ V_{\text{GEN}} = \text{-10 V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	P-Ch	-	9	13	
	+	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = \text{2} \ \Omega \\ I_{\text{D}} \cong \text{10 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$	N-Ch	-	22	33	115
Turn-Off Delay Time ^c	t _{d(off)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = \texttt{-20} \; V, \; R_L = 2 \; \Omega \\ I_D \cong \texttt{-10} \; A, \; V_GEN = \texttt{-10} \; V, \; R_g = 1 \; \Omega \end{array}$	P-Ch	-	43	64	
	+	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	10	16	
Fall Time ^c	t _f	$\label{eq:VDD} \begin{array}{l} V_{DD} = \text{-20 V, } R_L = 2 \ \Omega \\ I_D \cong \text{-10 A, } V_GEN = \text{-10 V, } R_g = 1 \ \Omega \end{array}$	P-Ch	-	19	28	
Source-Drain Diode Ratings and	Characteristics	b					
Pulsed Current ^a	lau		N-Ch	-	-	120	^
Pulsed Current ^a I _{SM}		P-Ch	-	-	-120	~	
Forward Voltage	Ver	I _S = 6.5 A	N-Ch	-	0.79	120 A	
l of ward voltage	V _{SD}	I _S = -3.4 A	P-Ch	-	-0.78	-1.2	v

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

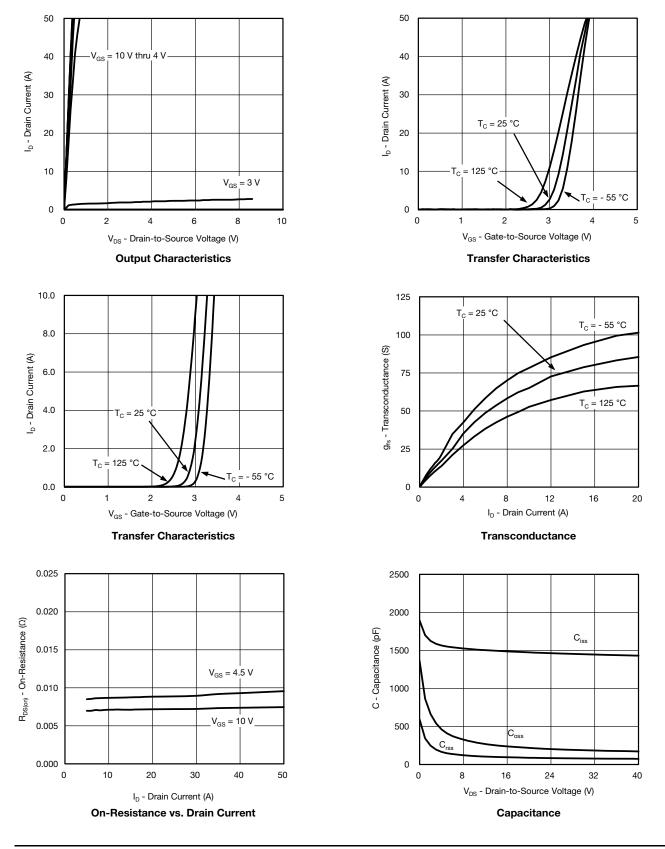
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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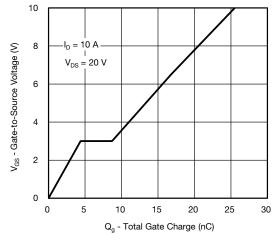
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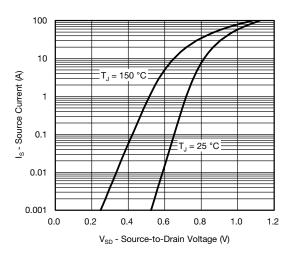
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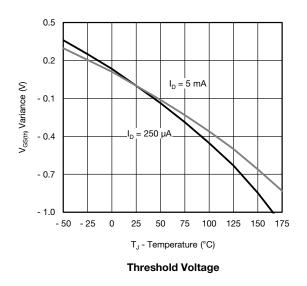
N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

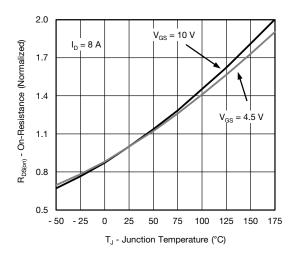




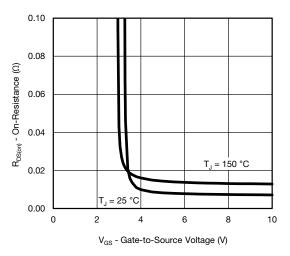


Source Drain Diode Forward Voltage

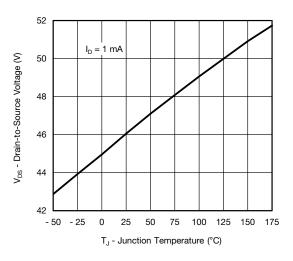




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

S13-2581-Rev. A, 23-Dec-13

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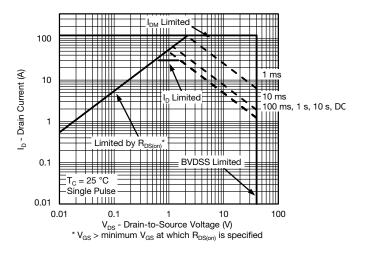
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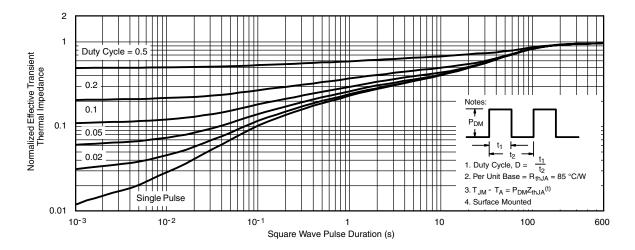


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N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



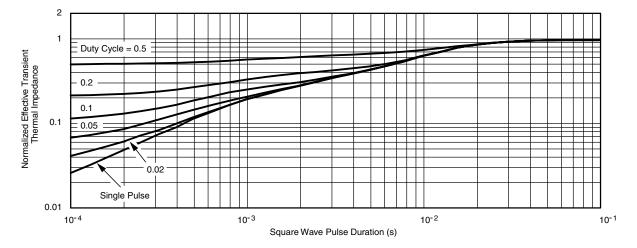
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

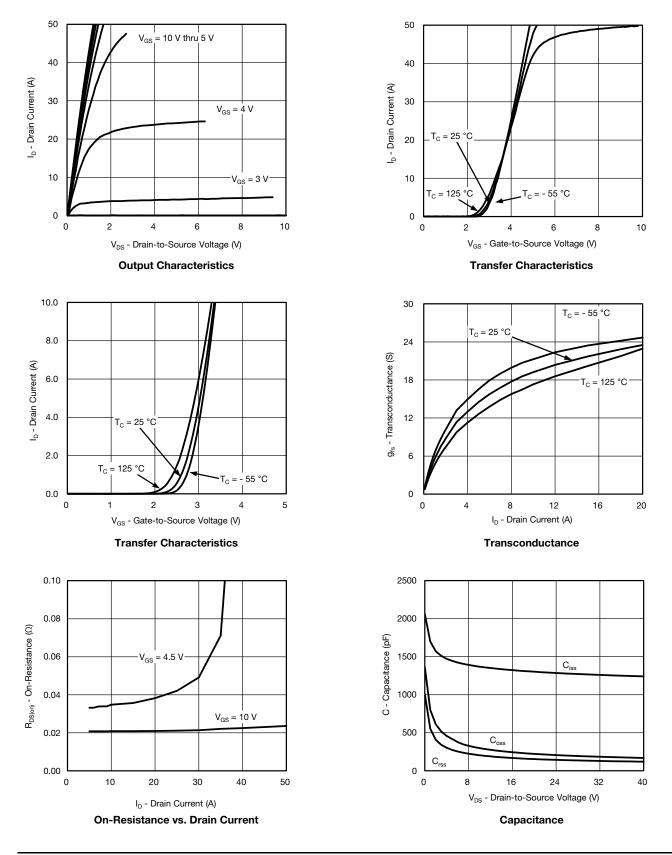
Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



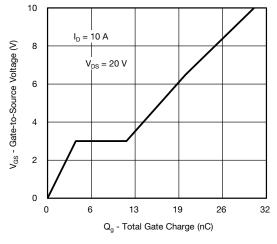
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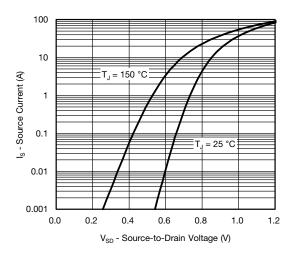
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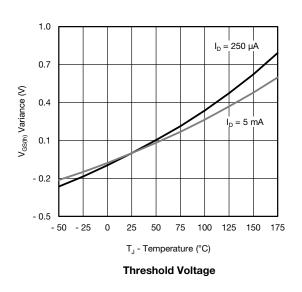
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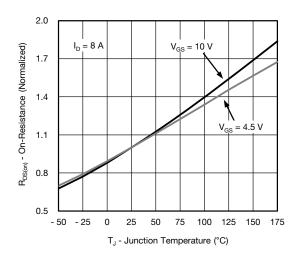




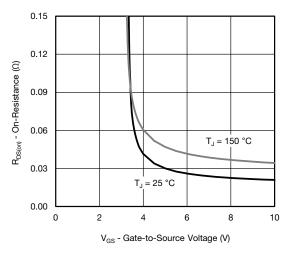


Source Drain Diode Forward Voltage

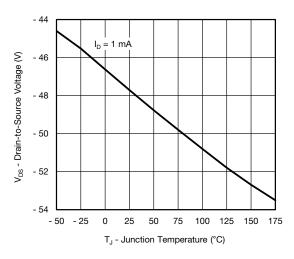




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

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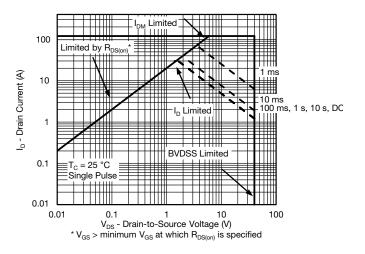
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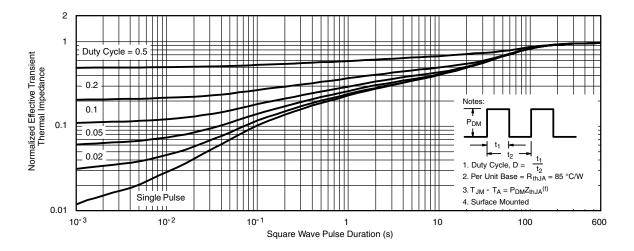


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P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



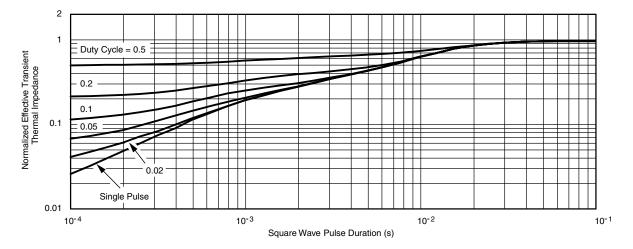
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

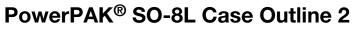
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

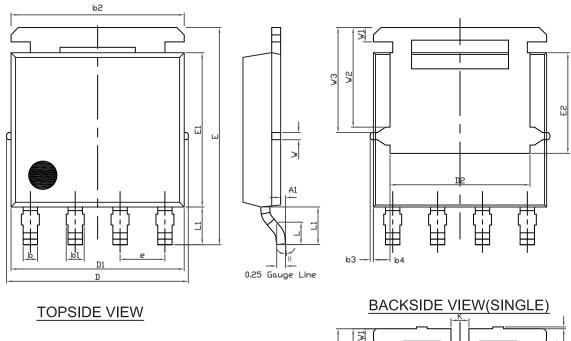
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

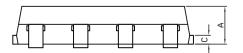
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

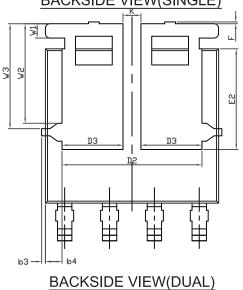
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62878.











Package Information



Vishay Siliconix

DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094			0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51			0.020			
W		0.23		0.009				
W1		0.41			0.016			
W2		2.82			0.111			
W3		2.96			0.117			
q	0°	-	10°	0°	-	10°		

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads Dimensions in mm (inches) Keep-out 6.75 (0.266) x 7.75 (0.305)

Revision: 07-Feb-12



Vishay

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